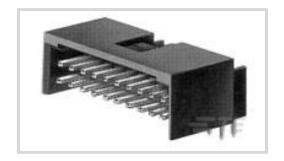


AMPMODU | AMPMODU Headers

TE Internal #: 2-103165-1 PCB Mount Header, Right Angle, Wire-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

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Connector System: Wire-to-Board

Number of Positions: **50**

Number of Rows: 2

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Orientation: Right Angle

Features

Product Type Features

Connector SystemWire-to-BoardHeader TypeFully ShroudedConnector & Contact Terminates ToPrinted Circuit Board



PCB Connector Assembly 7	Гуре
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PCB Mount Header

Configuration Features

Connector Contact Load Condition	Fully Loaded				
Number of Positions	50				
Number of Rows	2				
PCB Mount Orientation	Right Angle				
Electrical Characteristics					
Insulation Resistance	5000 ΜΩ				
Dielectric Withstanding Voltage (Max)	750 Vrms				
Body Features					
Connector Profile	Standard				
Primary Product Color	Black				
Contact Features					
Mating Square Post Dimension	.64 mm[.025 in]				
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]				

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PCB Mount Header, Right Angle, Wire-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
PCB Thickness (Recommended)	1.4 mm[.055 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Agency/Standard	CSA

PCB Mount Header, Right Angle, Wire-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	32	
Packaging Type	Tray	
Product Compliance For compliance documentation, visit the product page on TE.com>		
EU RoHS Directive 2011/65/EU	Not Compliant	
EU ELV Directive 2000/53/EC	Not Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2022 (224) SVHC > Threshold: Pb (40% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.	
Halogen Content	Not Yet Reviewed for halogen content	
Solder Process Capability	Wave solder capable to 240°C	

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Right Angle, Wire-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers





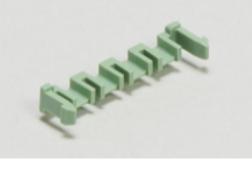


Also in the Series AMPMODU Headers



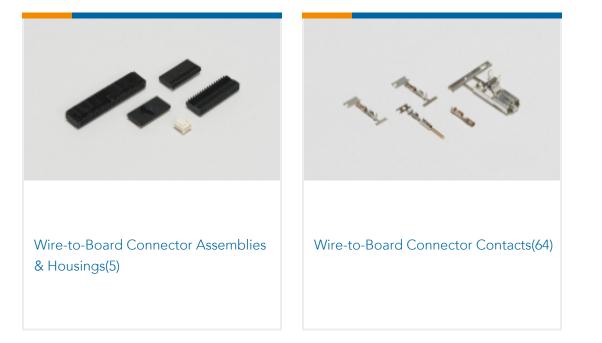






PCB Latches Lo cks & Reta

Connector Caps & Covers(1)	PCB Connector Mounting(1)	PCB Headers & Receptacles(4871)	PCB Latches, Locks & Retainers(1)



Customers Also Bought



PCB Mount Header, Right Angle, Wire-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers





Documents

Product Drawings 50 MODII HDR DRRA 3/4SHRD .100

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_2-103165-1_H.3d_igs.zip

English

Customer View Model

ENG_CVM_2-103165-1_H.3d_stp.zip

English

Customer View Model

ENG_CVM_2-103165-1_H.2d_dxf.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

English